

Echo-Cancelling Codec

Features

- **Applicable in:**
 - Digital-Cellular Hands Free
 - Analog-Cellular Hands Free
 - Office Speaker Phones
 - Desktop & Video Teleconferencing
 - Noise Cancellation
 - Network/Base Station
- **Echo Cancellation**
 - 512 Tap (64 ms at 8 kHz Fs)
 - Split Mode For Two ECs
 - Cascadable For Longer Response
 - Coefficient Dump/Restore
 - No Signal Delay
- **Zero-Glue Serial Data/Control Interface**
- **On-Chip Codec**
 - > 80 dB Dynamic Range
 - > 70 dB S/(N+D)
 - 300-3400 Hz Bandwidth
- **Optional Supplementary Voice Switching**

General Description

The CS6400 is an application-specific digital signal processor optimized for acoustic echo and noise cancellation applications. A high-quality codec is integrated with the processor to provide a complete, low-cost echo and noise-cancellation solution.

The CS6400 is a fully independent processor that requires no signal processing support to implement its cancellation functions. Volume control, mute, sleep, and two loopback functions are also provided.

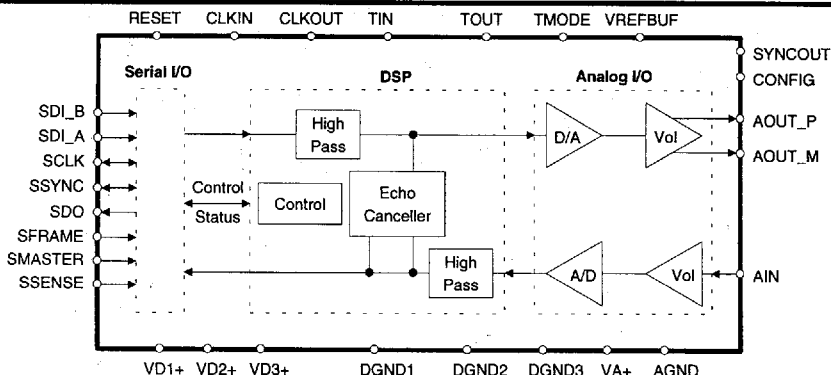
The on-chip A/D and D/A converters employ oversampling technology, which eliminates the need for complex external anti-aliasing and reconstruction filters, further reducing system cost.

The CS6400 has a zero glue-logic serial interface that is compatible with most DSPs. A clock and sync line control the transfer of serial data via the separate serial data-in and data-out pins. Both 15-bit audio data and control/status information are multiplexed on this serial channel using a steering bit.

The CS6400 can easily be tailored to special applications via metal-mask options. Custom development services for producing such derivatives are available from Crystal.

The CS6400 is packaged in a 28-pin PLCC.

ORDERING INFORMATION: CS6400



Preliminary Product Information

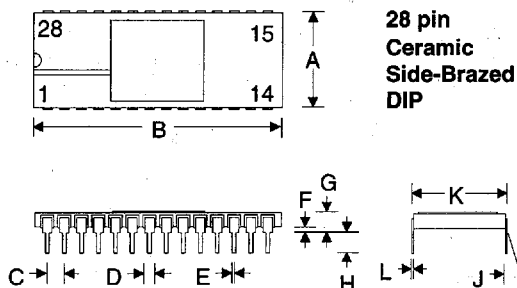
This document contains information for a new product. Crystal Semiconductor reserves the right to modify this product without notice.

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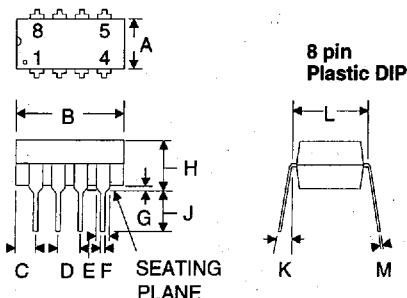
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AUG '93
DS80PP1
10-11

MECHANICAL DATA



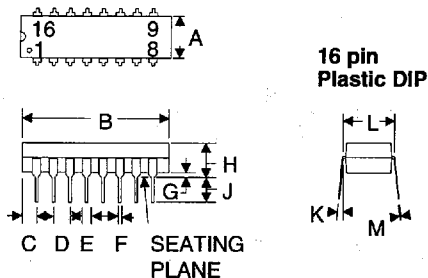
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	14.73	15.34	0.580	0.604
B	35.20	35.92	1.386	1.414
C	2.54 BSC		0.100 BSC	
D	0.76	1.40	0.030	0.055
E	0.38	0.53	0.015	0.021
F	1.02	1.52	0.040	0.060
G	2.79	4.32	0.110	0.170
H	2.54	4.57	0.100	0.180
J	-	10°	-	10°
K	14.99	15.49	0.590	0.610
L	0.20	0.30	0.008	0.012



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	6.10	6.60	0.240	0.260
B	9.14	10.2	0.360	0.400
C	0.38	1.52	0.015	0.060
D	2.54 BSC		0.100 BSC	
E	1.02	1.78	0.040	0.070
F	0.38	0.53	0.015	0.021
G	0.51	1.02	0.020	0.040
H	3.81	5.08	0.150	0.200
J	2.92	3.43	0.115	0.135
K	0°	10°	0°	10°
L	7.62BSC		0.300BSC	
M	0.20	0.38	0.008	0.015

NOTES:

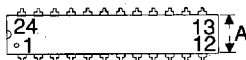
1. POSITIONAL TOLERANCE OF LEADS SHALL BE WITHIN 0.13MM (0.005") AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH.



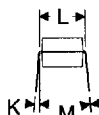
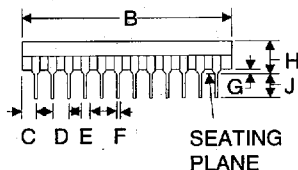
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	6.10	6.60	0.240	0.260
B	18.80	19.30	0.740	0.760
C	1.32	2.89	0.015	0.035
D	2.54 BSC		0.100 BSC	
E	1.02	1.78	0.040	0.070
F	0.38	0.53	0.015	0.021
G	0.51	1.02	0.020	0.040
H	3.81	5.08	0.150	0.200
J	2.92	3.43	0.115	0.135
K	0°	10°	0°	10°
L	7.62BSC		0.300BSC	
M	0.20	0.38	0.008	0.015

NOTES:

1. POSITIONAL TOLERANCE OF LEADS SHALL BE WITHIN 0.13MM (0.005") AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH.



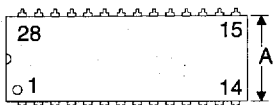
24 pin
Plastic
Skinny DIP



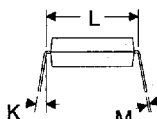
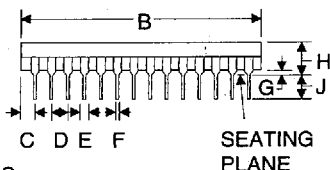
NOTES:

1. POSITIONAL TOLERANCE OF LEADS SHALL BE WITHIN 0.25MM (0.010") AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	6.10	6.60	0.240	0.260
B	31.37	32.13	1.235	1.265
C	1.65	2.16	0.065	0.085
D	2.54 BSC		0.100 BSC	
E	1.02	1.52	0.040	0.060
F	0.36	0.56	0.014	0.022
G	0.51	1.02	0.020	0.040
H	3.94	4.57	0.155	0.180
J	2.92	3.43	0.115	0.135
K	0°	15°	0°	15°
L	7.62 BSC		0.300 BSC	
M	0.20	0.38	0.008	0.015



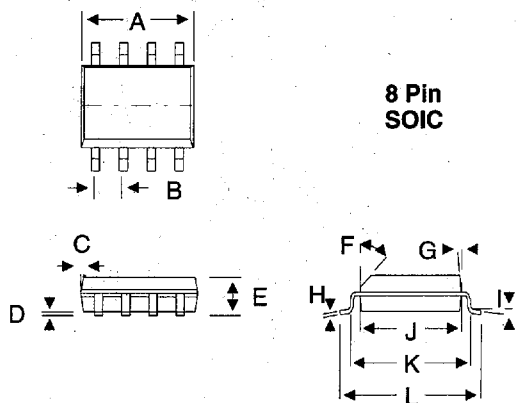
28 pin
Plastic DIP



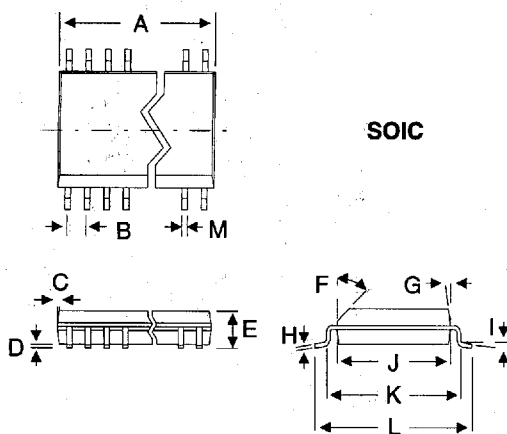
NOTES:

1. POSITIONAL TOLERANCE OF LEADS SHALL BE WITHIN 0.25MM (0.010") AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	13.72	14.22	0.540	0.560
B	36.45	37.21	1.435	1.465
C	1.65	2.16	0.065	0.085
D	2.54 BSC		0.100 BSC	
E	1.02	1.52	0.040	0.060
F	0.36	0.56	0.014	0.022
G	0.51	1.02	0.020	0.040
H	3.94	5.08	0.155	0.200
J	2.92	3.43	0.115	0.135
K	0°	15°	0°	15°
L	15.24 BSC		0.600 BSC	
M	0.20	0.38	0.008	0.015



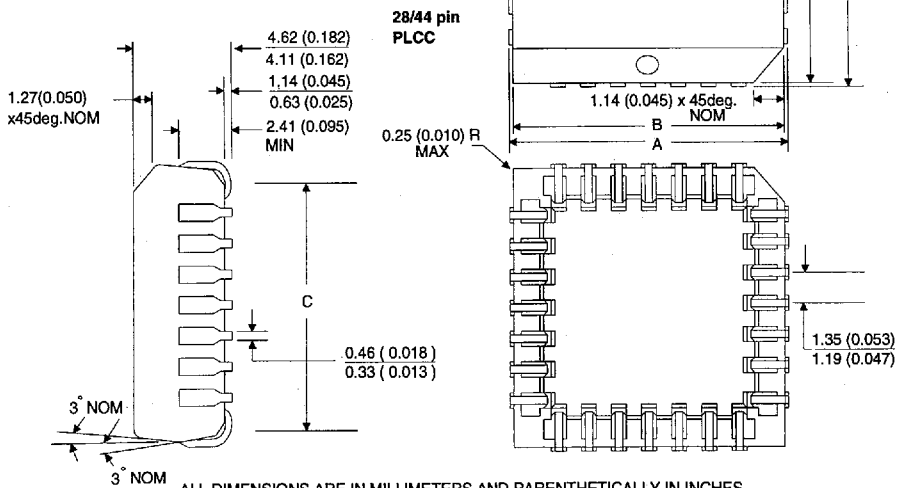
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	5.25	5.30	0.207	0.209
B	1.27 TYP		0.050 TYP	
C	7° NOM		7° NOM	
D	0.120	0.180	0.005	0.007
E	1.80	1.86	0.071	0.073
F	45° NOM		45° NOM	
G	7° NOM		7° NOM	
H	0.195	0.205	0.0078	0.0082
I	2°	4°	2°	4°
J	-	-	-	-
K	6.57	6.63	0.259	0.261
L	7.85	7.95	0.308	0.312



pins	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
16	9.91	10.41	0.390	0.410
20	12.45	12.95	0.490	0.510
24	14.99	15.50	0.590	0.610
28	17.53	18.03	0.690	0.710

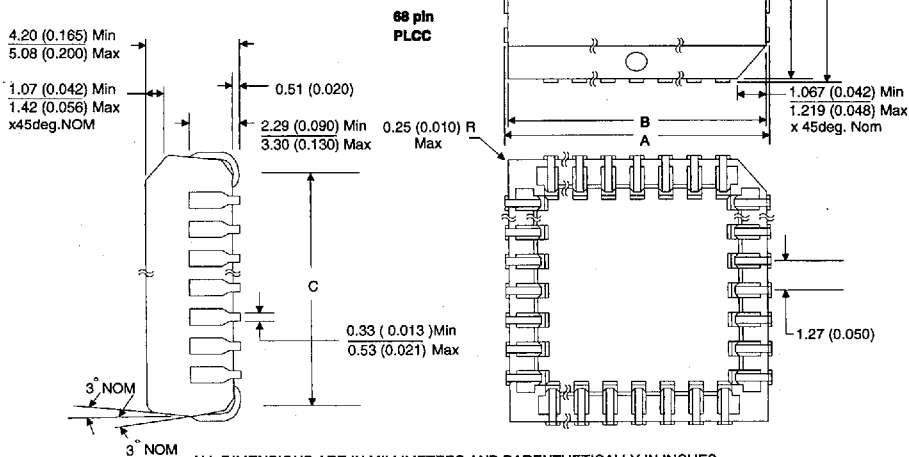
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	see table above			
B	1.27	BSC	0.050	BSC
C	7° NOM		7° NOM	
D	0.127	0.330	0.005	0.013
E	2.41	2.67	0.095	0.105
F	45° NOM		45° NOM	
G	7° NOM		7° NOM	
H	0.203	0.381	0.008	0.015
I	2°	8°	2°	8°
J	7.42	7.59	0.292	0.298
K	8.76	9.02	0.345	0.355
L	10.16	10.67	0.400	0.420
M	0.33	0.51	0.013	0.020

NO. OF TERMINAL	A		B		C	
	MIN	MAX	MIN	MAX	MIN	MAX
28	12.32 (0.485)	12.57 (0.495)	11.43 (0.450)	11.58 (0.456)	9.91 (0.390)	10.92 (0.430)
44	17.40 (0.685)	17.65 (0.695)	16.51 (0.650)	16.66 (0.656)	14.98 (0.590)	16.00 (0.630)



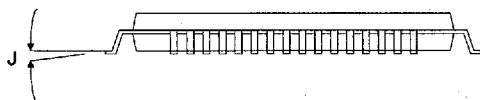
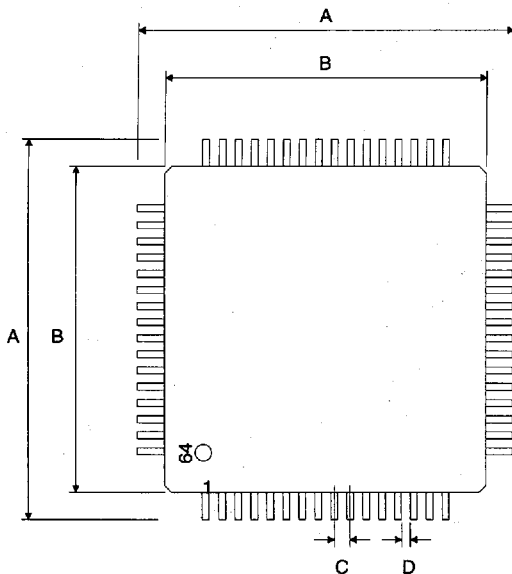
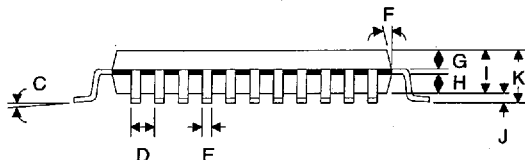
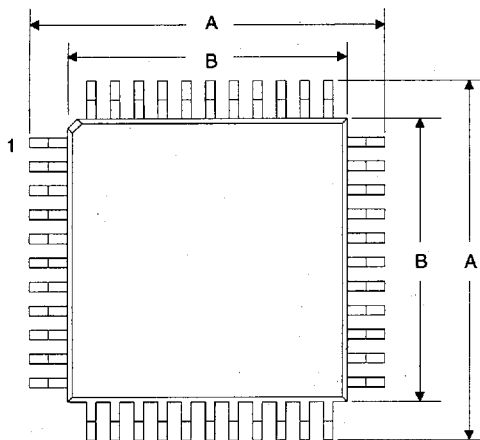
ALL DIMENSIONS ARE IN MILLIMETERS AND PARENTHETICALLY IN INCHES.

	A		B		C	
	MIN	MAX	MIN	MAX	MIN	MAX
68	25.02 (0.985)	25.27 (0.995)	24.13 (0.950)	24.33 (0.958)	22.61 (0.890)	23.62 (0.930)

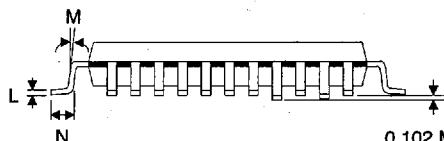


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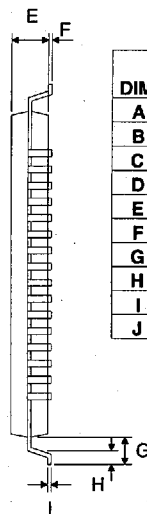
44 PIN QUAD FLATPACK



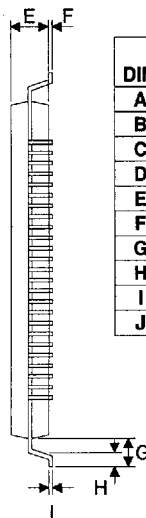
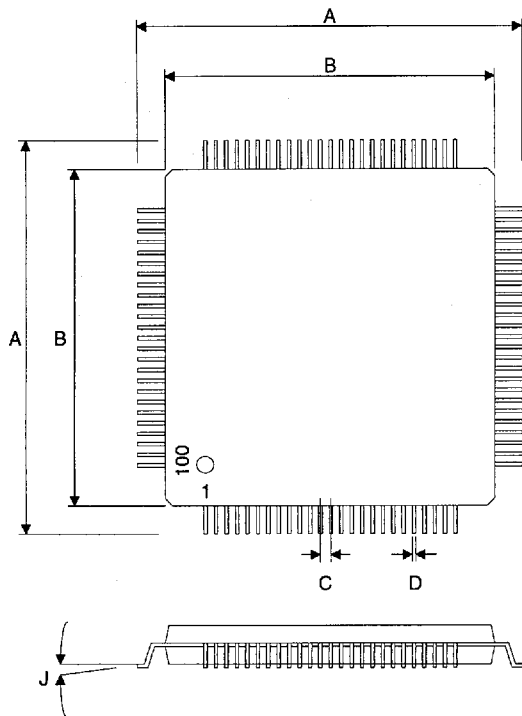
44 Pin TQFP				
1.4 mm Package Thickness				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	11.75	12.25	0.463	0.482
B	9.90	10.10	0.390	0.398
C	0°	7°	0°	7°
D	0.80 BSC		0.031 BSC	
E	0.35 BSC		0.014 BSC	
F	12°		12°	
G	0.54	0.74	0.021	0.029
H	0.54	0.74	0.021	0.029
I	1.35	1.50	0.053	0.059
J	0.05		0.002	
K		1.60		0.063
L		0.17		0.007
M	2°	10°	2°	10°
N	0.35	0.65	0.014	0.026



0.102 MAX
Lead Coplanarity



64 Pin TQFP				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	12.00 BSC		0.472 BSC	
B	10.00 BSC		0.393 BSC	
C	0.50 BSC		0.020 BSC	
D	0.14	0.30	0.005	0.012
E	0.95	1.12	0.037	0.044
F	0.05	0.15	0.002	0.006
G	1.00 BSC		0.039 BSC	
H	0.45	0.75	0.018	0.030
I	0.09	0.18	0.003	0.007
J	0°	7°	0°	7°



100-pin TQFP

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	15.75	16.25	0.620	0.640
B	13.90	14.10	0.547	0.555
C	0.50 BSC		0.020 BSC	
D	0.10	0.20	0.004	0.012
E	1.25	1.55	0.049	0.061
F	0.00	0.20	0.000	0.008
G	1.00 BSC		0.039 BSC	
H	0.35	0.65	0.014	0.026
I	0.077	0.177	0.003	0.007
J	0°	10°	0°	10°